BTA08-600BW3G, BTA08-800BW3G

Triacs

Silicon Bidirectional Thyristors

Designed for high performance full-wave ac control applications where high noise immunity and high commutating di/dt are required.

Features

- Blocking Voltage to 800 V
- On-State Current Rating of 8 A RMS at 80°C
- Uniform Gate Trigger Currents in Three Quadrants
- High Immunity to dV/dt – 2000 V/μs minimum at 125°C
- Minimizes Snubber Networks for Protection
- Industry Standard TO-220AB Package
- High Commutating dI/dt – 1.5 A/ms minimum at 125°C
- Internally Isolated (2500 V_{RMS})
- These Devices are Pb−Free and are RoHS Compliant*

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off−State Voltage (Note 1) (T_J = −40 to 125°C, Sine Wave, 50 to 60 Hz, Gate Open) BTA08−600BW3G BTA08−800BW3G	V_{DRM}, V_{RRM}	 600 800	V
On-State RMS Current (Full Cycle Sine Wave, 60 Hz, T_C = 80°C)	$I_{T(RMS)}$	8.0	A
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T_C = 25°C)	I_{TSM}	90	A
Circuit Fusing Consideration (t = 8.3 ms)	I^2t	36	A^2sec
Non−Repetitive Surge Peak Off−State Voltage (T_J = 25°C, t = 10ms)	V_{DSM}/ V_{RSM}	V_{DSM}/V_{RSM} +100	V
Peak Gate Current (T_J = 125°C, t = 20ms)	I_{GM}	4.0	A
Peak Gate Power (Pulse Width ≤ 1.0 μs, T_C = 80°C)	P_{GM}	20	W
Average Gate Power (T_J = 125°C)	$P_{G(AV)}$	1.0	W
Operating Junction Temperature Range	T_J	−40 to +125	°C
Storage Temperature Range	T_{stg}	−40 to +150	°C
RMS Isolation Voltage (t = 300 ms, R.H. ≤ 30%, T_A = 25°C)	V_{iso}	2500	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

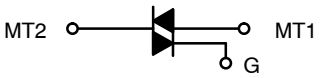
1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

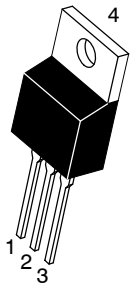
*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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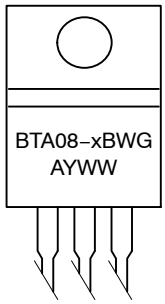
TRIACS
8 AMPERES RMS
600 thru 800 VOLTS





TO−220AB
CASE 221A
STYLE 12

MARKING DIAGRAM



x = 6 or 8
A = Assembly Location (Optional)*
Y = Year
WW = Work Week
G = Pb−Free Package

* The Assembly Location code (A) is optional. In cases where the Assembly Location is stamped on the package the assembly code may be blank.

PIN ASSIGNMENT	
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	No Connection

ORDERING INFORMATION

Device	Package	Shipping
BTA08−600BW3G	TO−220AB (Pb−Free)	50 Units / Rail
BTA08−800BW3G	TO−220AB (Pb−Free)	50 Units / Rail

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THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction−to−Case (AC) Junction−to−Ambient	$R_{\theta JC}$ $R_{\theta JA}$	2.5 63	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8″ from Case for 10 seconds	T_L	260	°C

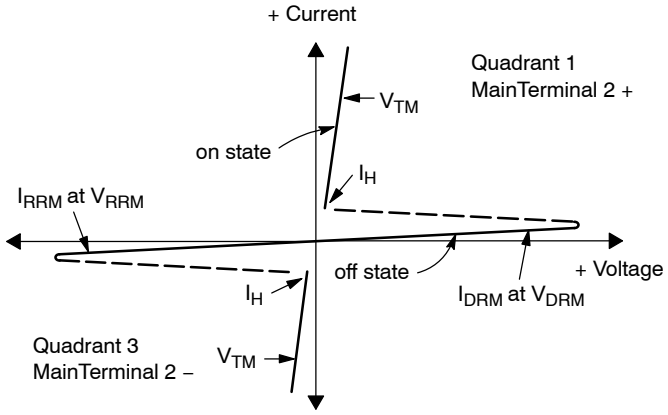
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted; Electricals apply in both directions)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Peak Repetitive Blocking Current (V_D = Rated V_{DRM}, V_{RRM}; Gate Open) T_J = 25°C T_J = 125°C	I_{DRM}, I_{RRM}	 − −	 − −	 0.005 2.0	mA
ON CHARACTERISTICS					
Peak On-State Voltage (Note 2) (I_{TM} = ±11 A Peak)	V_{TM}	−	−	1.55	V
Gate Trigger Current (Continuous dc) (V_D = 12 V, R_L = 30 Ω) MT2(+), G(+) MT2(+), G(−) MT2(−), G(−)	I_{GT}	 2.5 2.5 2.5	 − − −	 50 50 50	mA
Holding Current (V_D = 12 V, Gate Open, Initiating Current = ±100 mA)	I_H	−	−	60	mA
Latching Current (V_D = 12 V, I_G = 60 mA) MT2(+), G(+) MT2(+), G(−) MT2(−), G(−)	I_L	 − − −	 − − −	 70 90 70	mA
Gate Trigger Voltage (V_D = 12 V, R_L = 30 Ω) MT2(+), G(+) MT2(+), G(−) MT2(−), G(−)	V_{GT}	 0.5 0.5 0.5	 − − −	 1.7 1.1 1.1	V
Gate Non−Trigger Voltage (T_J = 125°C) MT2(+), G(+) MT2(+), G(−) MT2(−), G(−)	V_{GD}	 0.2 0.2 0.2	 − − −	 − − −	V
DYNAMIC CHARACTERISTICS					
Rate of Change of Commutating Current, See Figure 10. (Gate Open, T_J = 125°C, No Snubber)	$(dI/dt)_c$	1.5	−	−	A/ms
Critical Rate of Rise of On−State Current (T_J = 125°C, f = 120 Hz, I_G = 2 x I_{GT}, tr ≤ 100 ns)	dI/dt	−	−	50	A/μs
Critical Rate of Rise of Off-State Voltage (V_D = 0.66 x V_{DRM}, Exponential Waveform, Gate Open, T_J = 125°C)	dV/dt	2000	−	−	V/μs

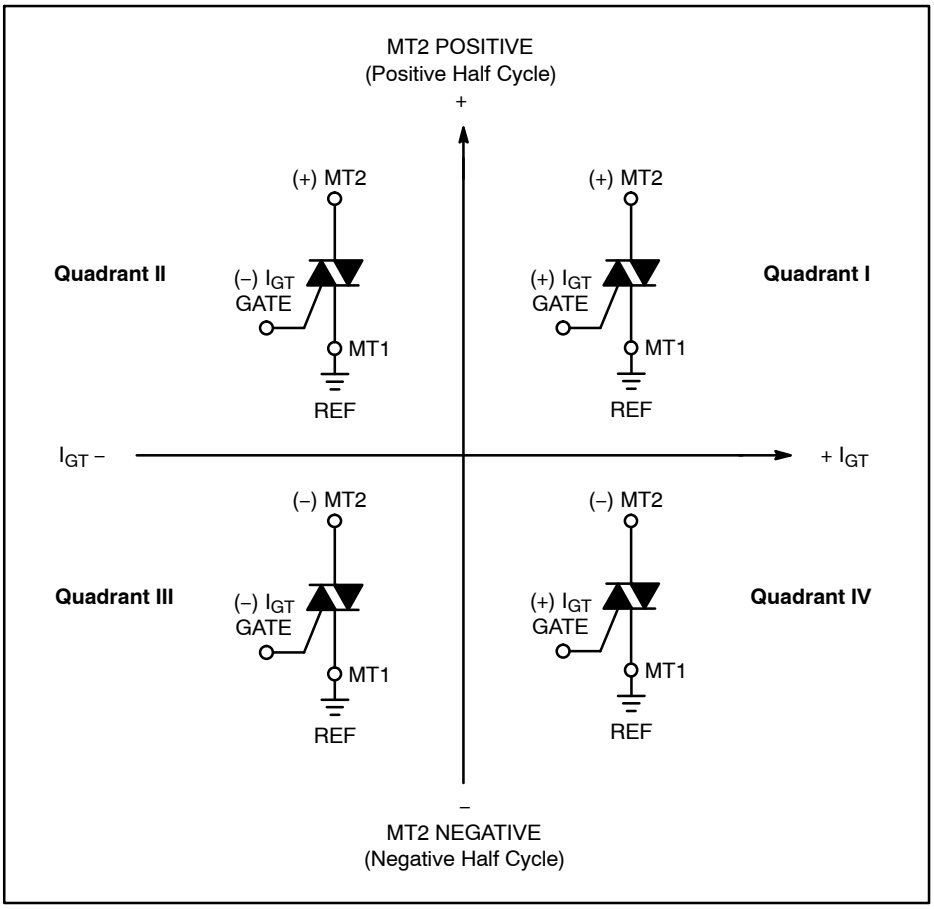
2. Indicates Pulse Test: Pulse Width ≤ 2.0 ms, Duty Cycle ≤ 2%.

Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
V_{DRM}	Peak Repetitive Forward Off State Voltage
I_{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Reverse Off State Voltage
I_{RRM}	Peak Reverse Blocking Current
V_{TM}	Maximum On State Voltage
I_H	Holding Current



Quadrant Definitions for a Triac



All polarities are referenced to MT1.
With in−phase signals (using standard AC lines) quadrants I and III are used.

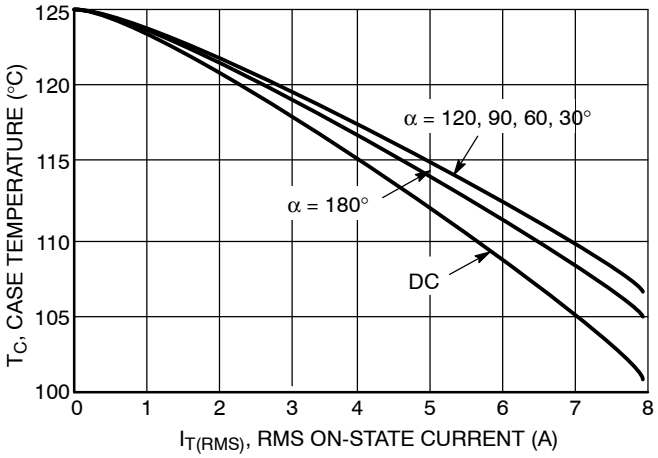


Figure 1. RMS Current Derating

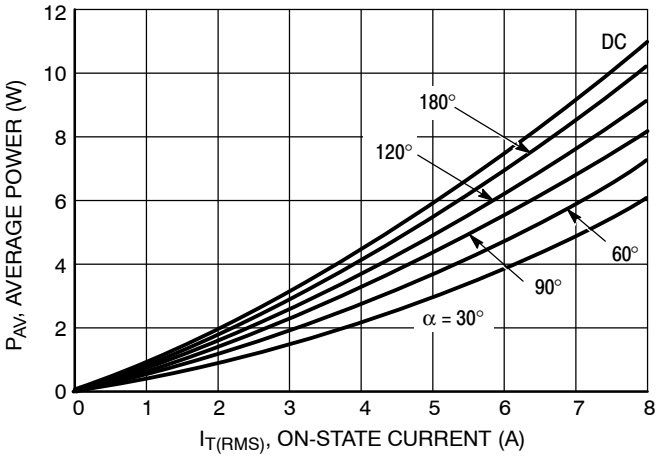


Figure 2. On-State Power Dissipation

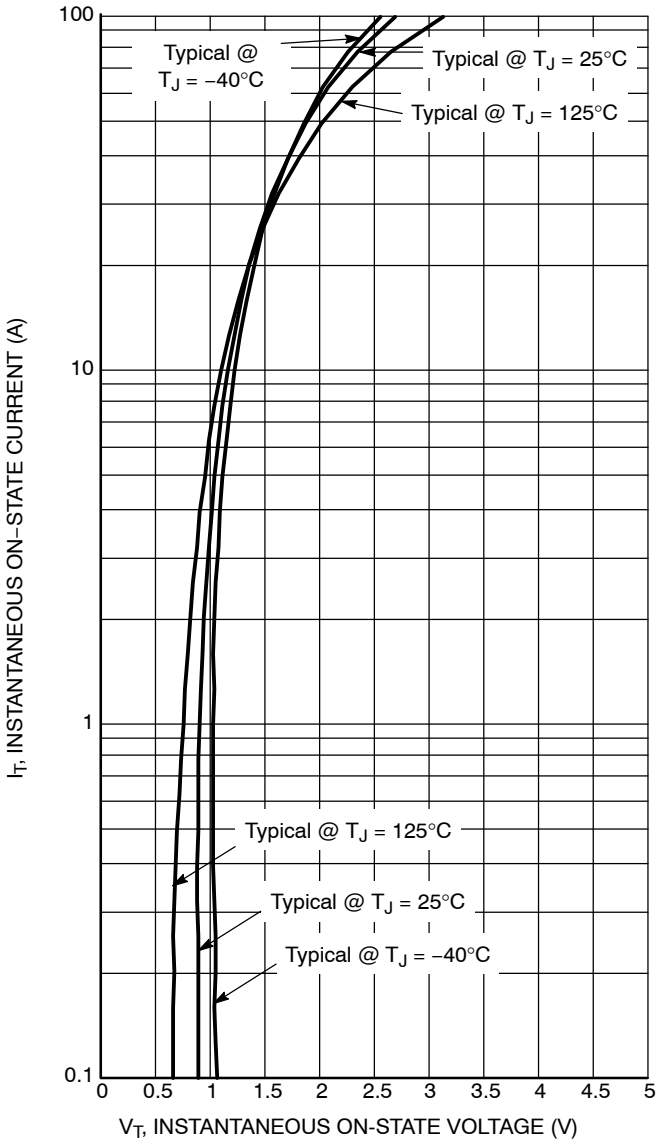


Figure 3. On-State Characteristics

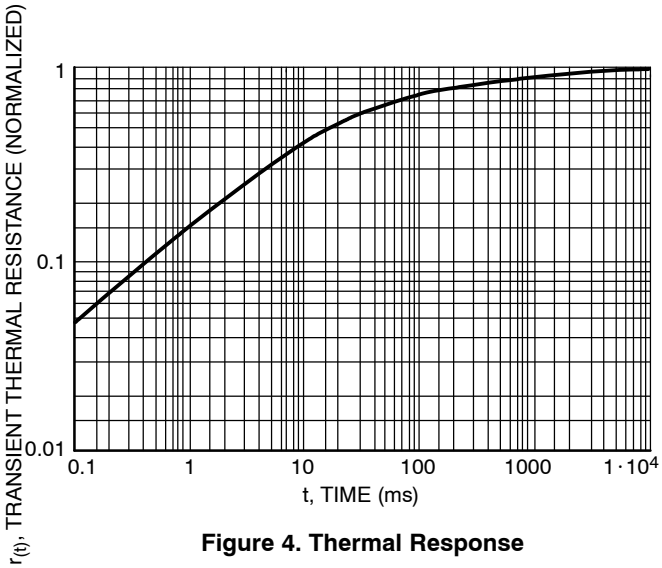


Figure 4. Thermal Response

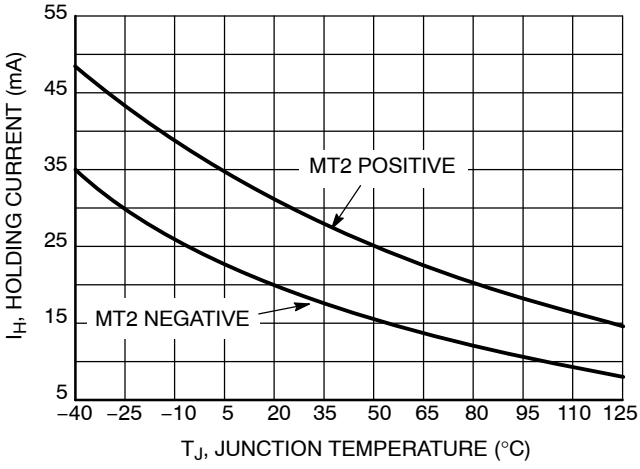


Figure 5. Holding Current Variation

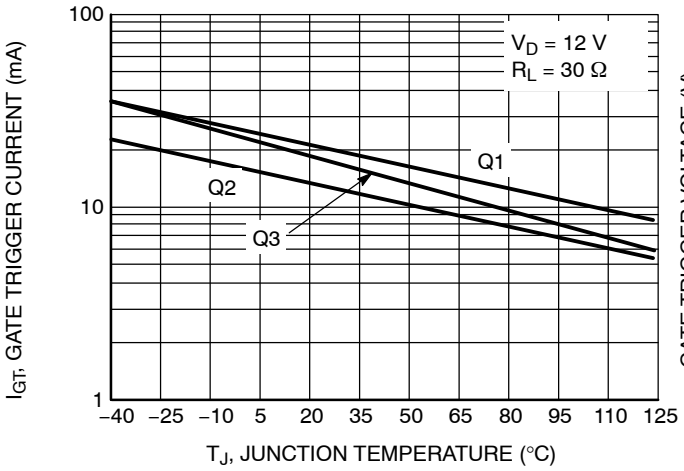


Figure 6. Gate Trigger Current Variation

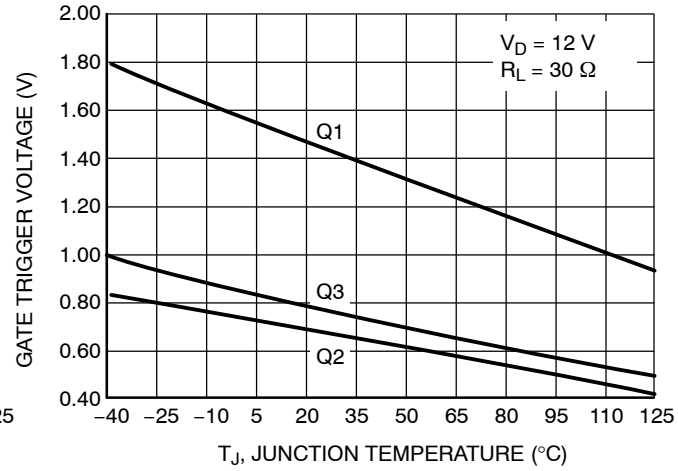


Figure 7. Gate Trigger Voltage Variation

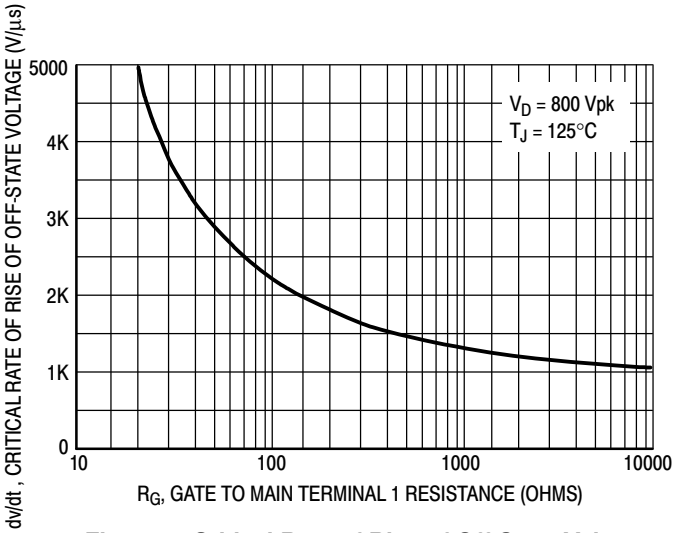


Figure 9. Critical Rate of Rise of Off-State Voltage (Exponential Waveform)

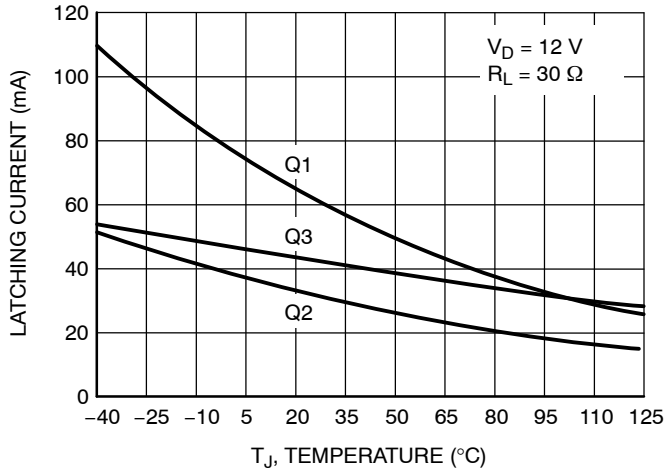
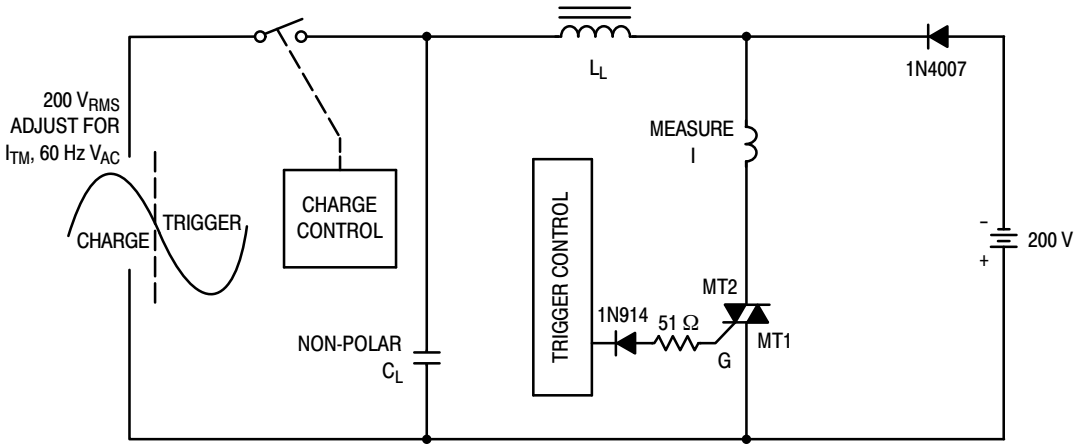


Figure 10. Latching Current Variation

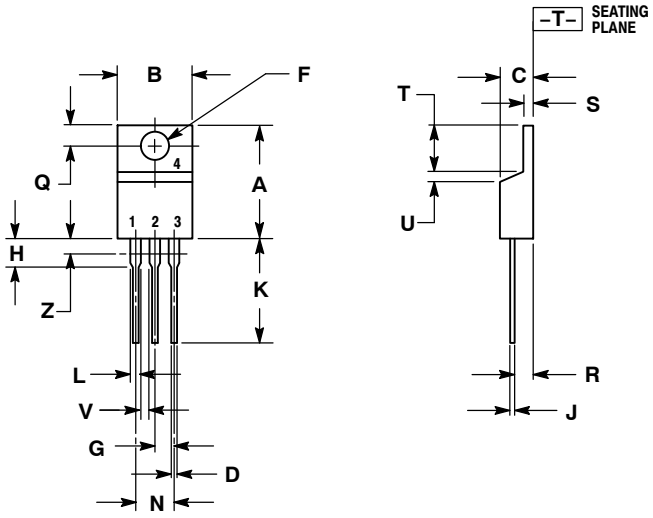


Note: Component values are for verification of rated $(di/dt)_c$. See AN1048 for additional information.

Figure 8. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current $(di/dt)_c$

PACKAGE DIMENSIONS

TO−220
CASE 221A−07
ISSUE AA



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.570	0.620	14.48	15.75
B	0.380	0.405	9.66	10.28
C	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
H	0.110	0.155	2.80	3.93
J	0.014	0.022	0.36	0.55
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	---	1.15	---
Z	---	0.080	---	2.04

STYLE 12:
PIN 1. MAIN TERMINAL 1
2. MAIN TERMINAL 2
3. GATE
4. NOT CONNECTED

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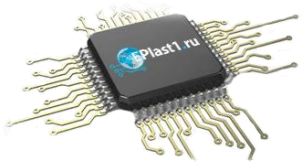
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